

This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice.

Contact technical support at http://www.maxim-ic.com/support for further questions.

PACKAGE LAND PATTERN,
[W28] 0.300" SDIC, 28 LEADS

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